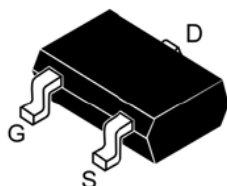
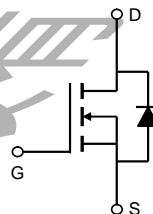


**General Description**

The AO3400/A combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is suitable for use as a load switch or in PWM applications.

Product Summary

V_{DS}	30V
I_D (at $V_{GS}=12V$)	5.2A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 28m Ω
$R_{DS(ON)}$ (at $V_{GS} = 4.5V$)	< 33m Ω

● **Pin Configuration****SOT23****Absolute Maximum Ratings** $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	5.7	A
$T_A=25^\circ\text{C}$			
$T_A=70^\circ\text{C}$		4.7	
Pulsed Drain Current ^C	I_{DM}	30	
Power Dissipation ^B	P_D	1.4	W
$T_A=25^\circ\text{C}$			
$T_A=70^\circ\text{C}$		0.9	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	70	90	$^\circ\text{C/W}$
$t \leq 10s$				
Maximum Junction-to-Ambient ^{A,D}	$R_{\theta JA}$	100	125	$^\circ\text{C/W}$
Steady-State				
Maximum Junction-to-Lead	$R_{\theta JL}$	63	80	$^\circ\text{C/W}$
Steady-State				

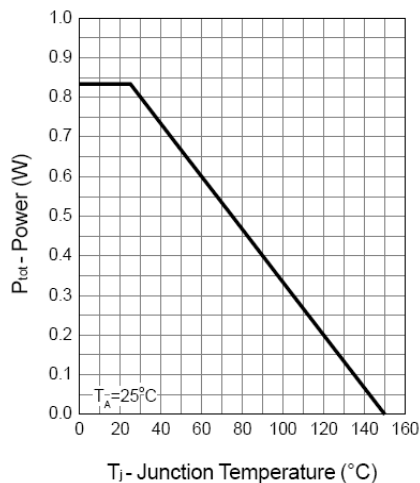
Electrical Characteristics (T_j=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} =0V T _j =55°C			1 30	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} = ±12V			100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} I _D =250μA	0.5	0.7	1	V
I _{D(ON)}	On state drain current	V _{GS} =4.5V, V _{DS} =5V	30			A
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =6A T _j =125°C		23 28	29 38	mΩ
		V _{GS} =4.5V, I _D =4.8A		24	30	mΩ
		V _{GS} =2.5V, I _D =3.5A		28	35	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =5.7A		33		S
V _{SD}	Diode Forward Voltage	I _S =1.25A, V _{GS} =0V		0.7	1.3	V
I _S	Maximum Body-Diode Continuous Current				2	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz		680		pF
C _{oss}	Output Capacitance			250		pF
C _{rss}	Reverse Transfer Capacitance			200		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		6		Ω
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =10V, I _D =6A		5	10	nC
Q _{gs}	Gate Source Charge			1		nC
Q _{gd}	Gate Drain Charge			1.1		nC
t _{D(on)}	Turn-On DelayTime	V _{DD} =10V, R _L =10Ω, I _{DS} =1A, V _{GEN} =4.5V, R _G =6Ω		8	15	ns
t _r	Turn-On Rise Time			6	12	ns
t _{D(off)}	Turn-Off DelayTime			19	35	ns
t _f	Turn-Off Fall Time			7	23	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =5.7A, dI/dt=100A/μs	7	8.5	10	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =5.7A, dI/dt=100A/μs	2	2.6	3.1	nC

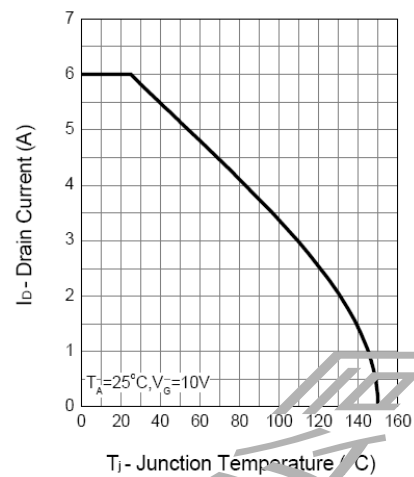
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● Typical Performance Characteristics

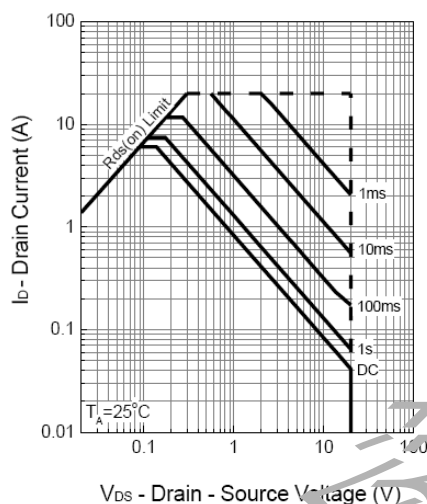
Power Dissipation



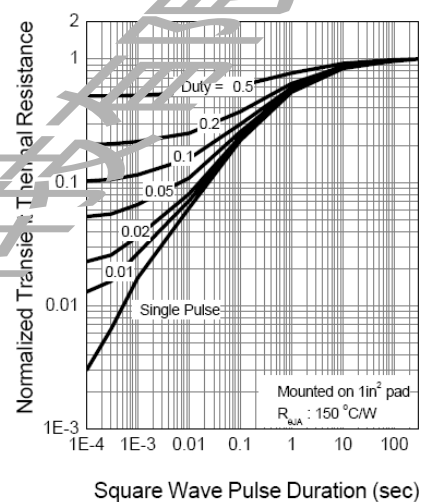
Drain Current



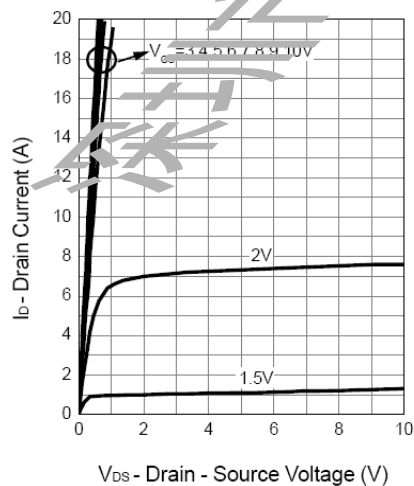
Safe Operation Area



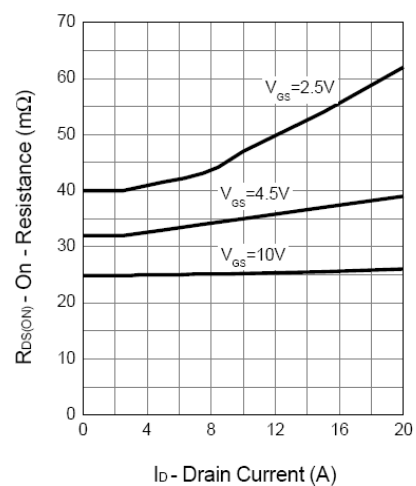
Thermal Transient Impedance



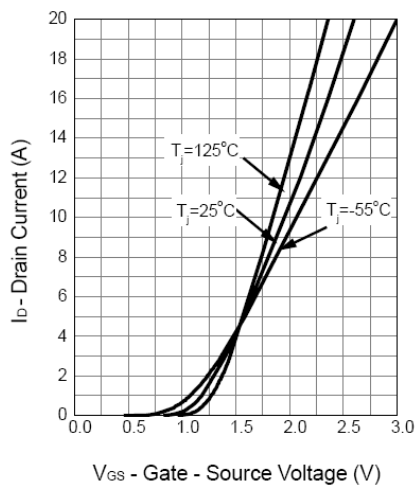
Output Characteristics



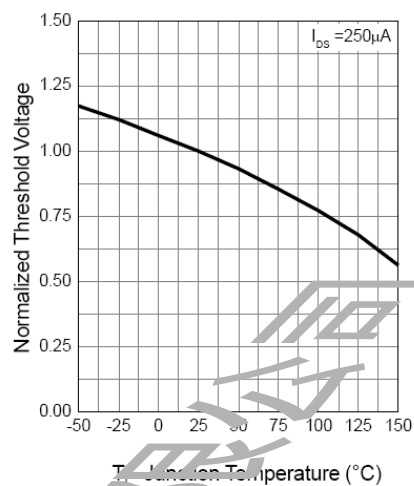
Drain-Source On Resistance



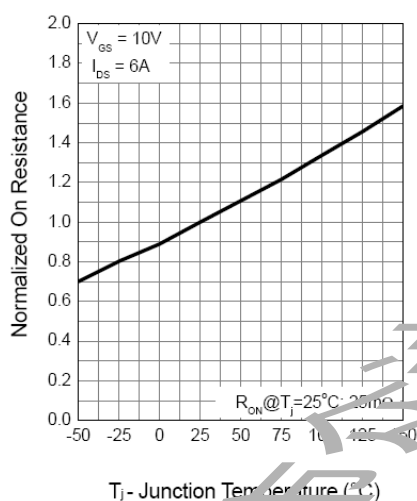
Transfer Characteristics



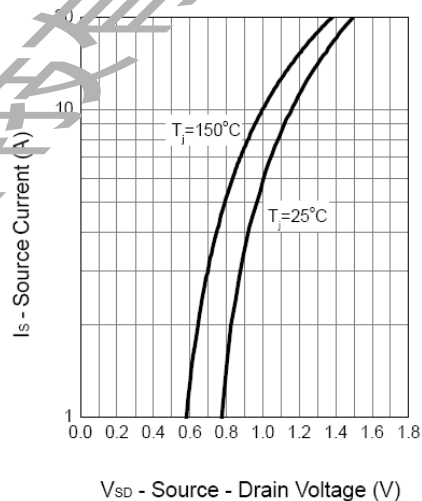
Gate Threshold Voltage



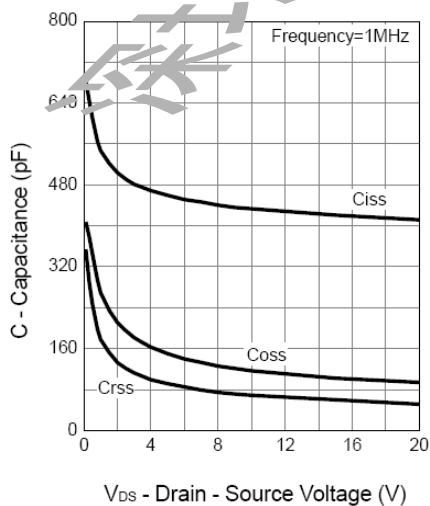
Drain-Source On Resistance



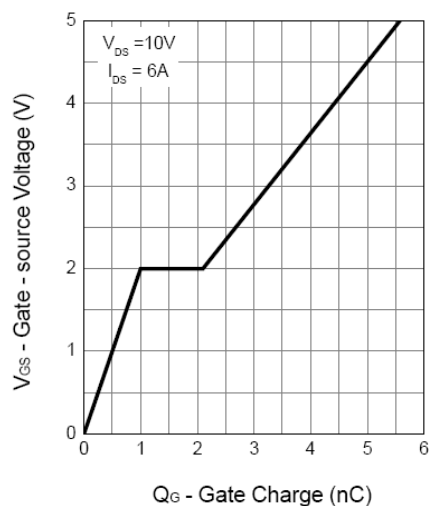
Source-Drain Diode Forward



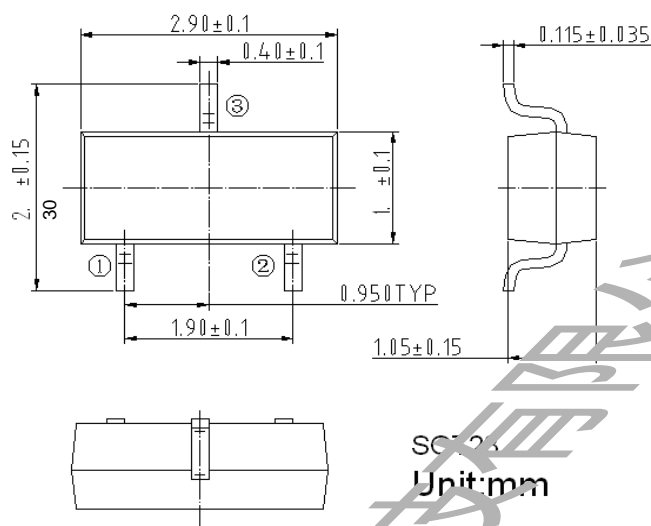
Capacitance



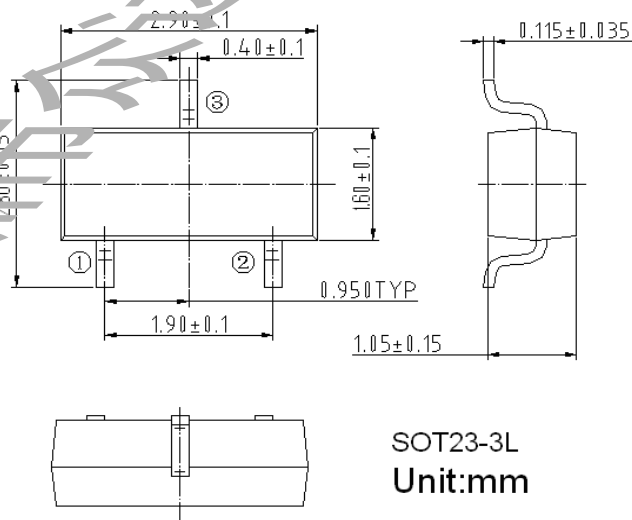
Gate Charge



● Package Information



AO3400



AO3400A

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